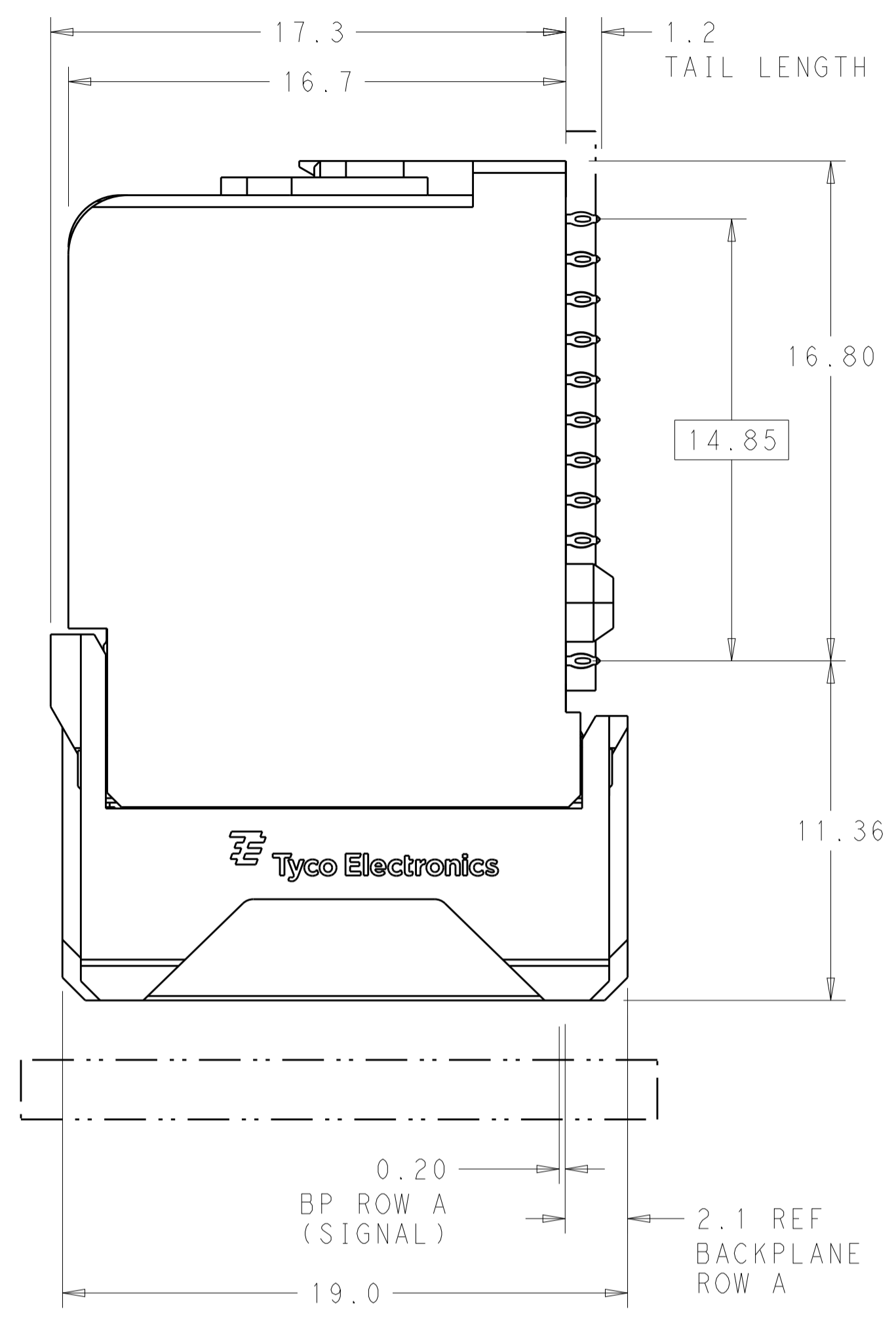
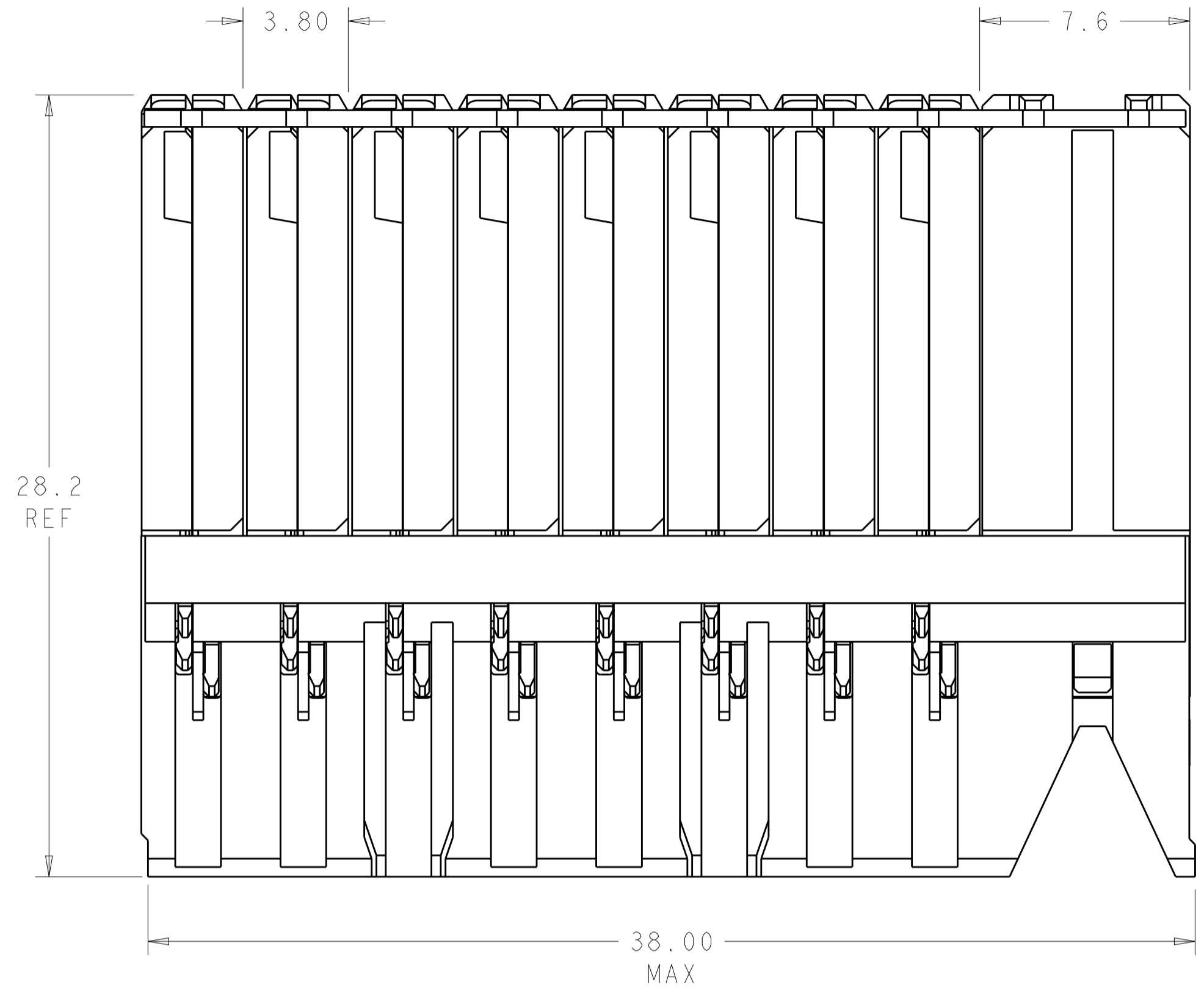


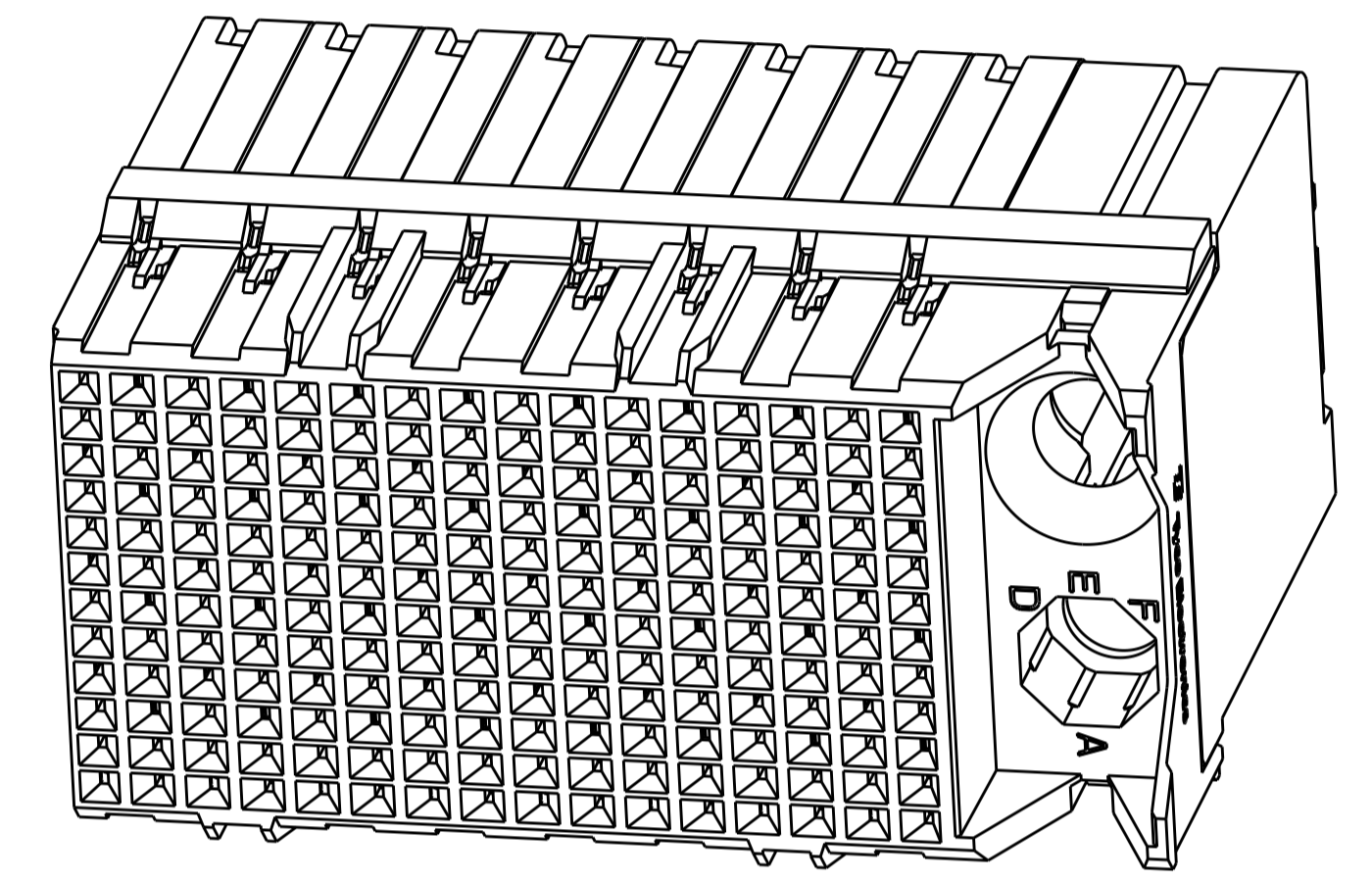
LOC	DIST	REVISIONS			
P	LTN	DESCRIPTION	DATE	DWN	APVD
B1		REVISED PER ECO-14-018036	17FEB2015	AP	DD



⚠ MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

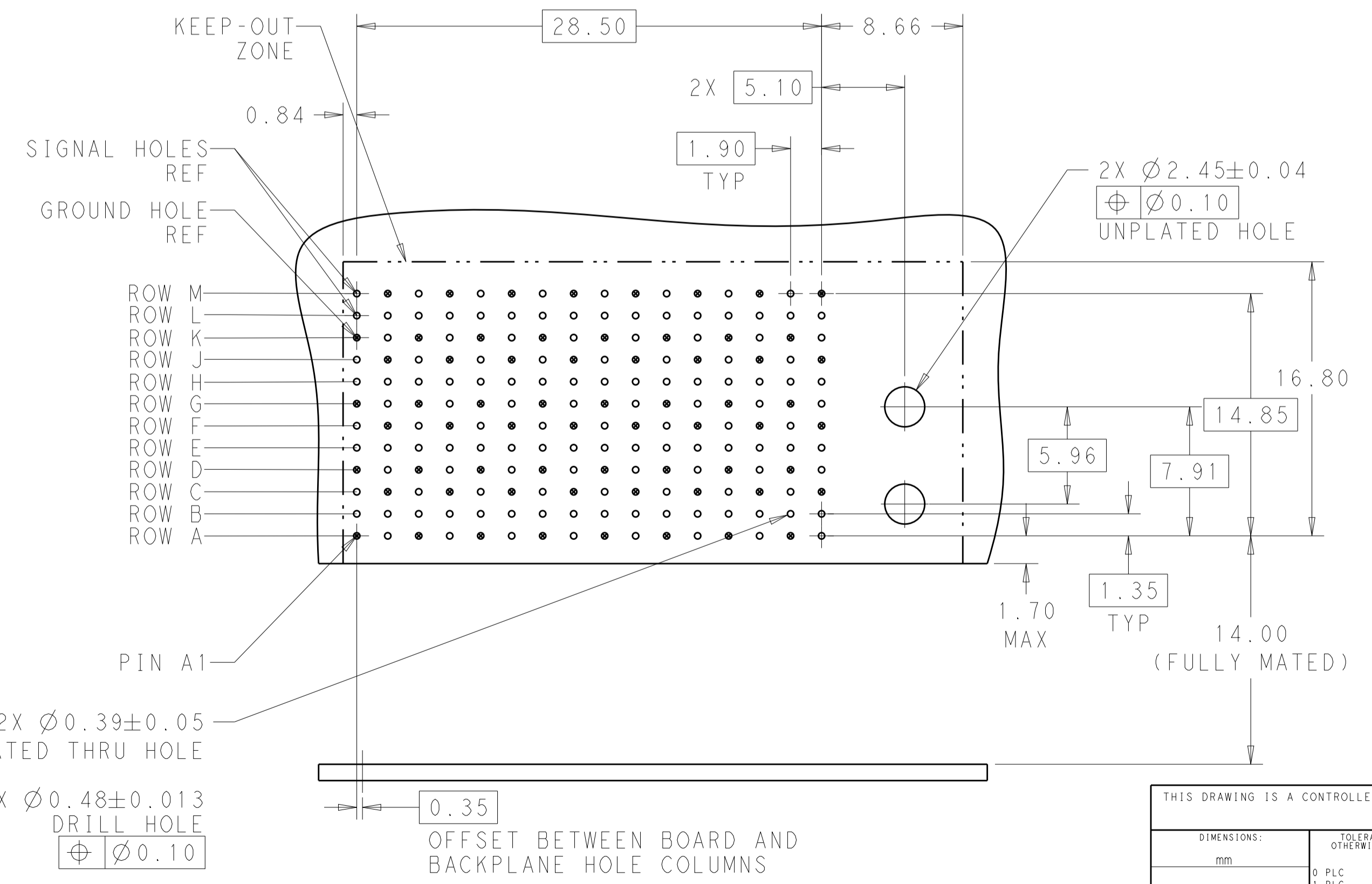
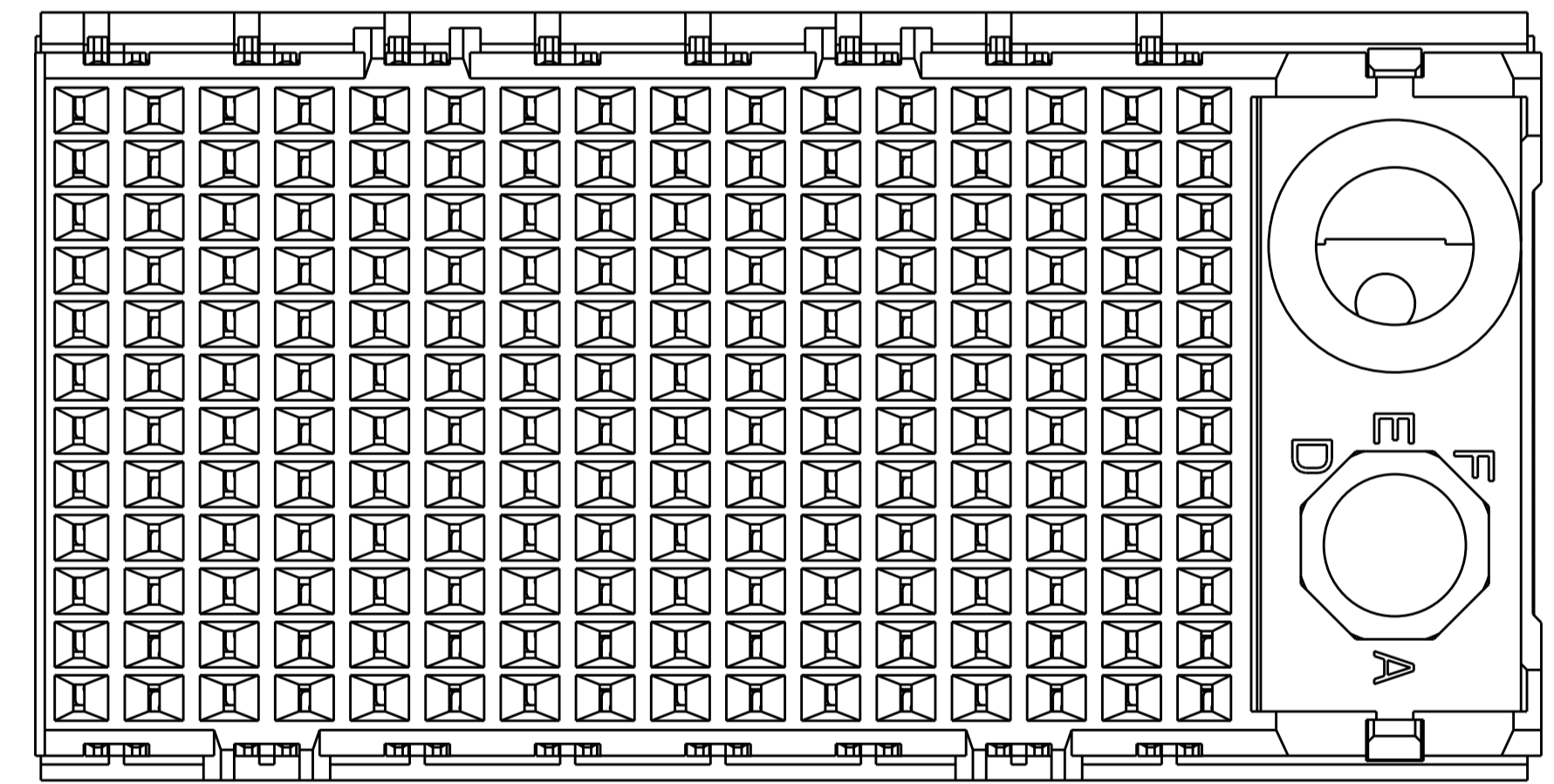
⚠ FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.

3. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM FOR PRODUCT AVAILABILITY



KEY POSITION CHART	
	NONE
	A
	B
	C
	D
	E
	F
	G
	H

192X Ø0.39±0.05 PLATED THRU HOLE

192X Ø0.48±0.013 DRILL HOLE

Ø0.10

0.35 OFFSET BETWEEN BOARD AND BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

KEY POSITION	FINISH	PART NUMBER
H	⚠	8-2007722-1
G	⚠	7-2007722-1
F	⚠	6-2007722-1
E	⚠	5-2007722-1
D	⚠	4-2007722-1
C	⚠	3-2007722-1
B	⚠	2-2007722-1
A	⚠	1-2007722-1
NONE	⚠	2007722-1

THIS DRAWING IS A CONTROLLED DOCUMENT.

DWN: 18MAY2011
CHK: D. DIXON 18MAY2011
APVD: D. DIXON 18MAY2011

TE Connectivity

NAME: IMPACT, 4 PAIR, DAUGHTERCARD 16 COLUMN, RIGHT GUIDED, SIGNAL MODULE, 0.39 EYELET

SIZE: A1 00779 ©=2007722

SCALE: 6:1 SHEET: 1 OF 1 REV: B1

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)